

## Processor Power Management Subsystem

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### DESCRIPTION

WM8311 is an integrated power-management subsystem which provides a cost-effective, flexible, single-chip solution for power management, specifically targeted at the requirements of a range of low-power portable applications. WM8311 is specifically designed to operate as a system PMIC supporting a variety of industry standard processors and accessories in a wide range of applications.

The start-up behaviour and configuration is fully programmable in an integrated OTP non-volatile memory. This highly flexible solution helps reduce time-to-market, as changing application requirements can be very easily accommodated.

The WM8311 power management subsystem comprises of four programmable DC-DC converters, seven LDO regulators (one of which is low-noise for supplying sensitive analogue subsystems). The integrated OTP bootstrap circuitry controls the start-up sequencing and voltages of the converters and regulators as well as the sequencing of system clocks.

WM8311 can be powered from a battery, a wall adaptor or from a USB power source. An on-chip regulator provides power for always-on PMIC functions such as register map and the RTC. The device provides autonomous backup battery switchover. A low-power LDO is included to support 'alive' processor power domains external to the WM8311.

A linear on-chip battery charger supports trickle charging and constant current/constant voltage charging of single-cell lithium-ion/lithium-polymer batteries. The charge current, termination voltage, and charger time-out are programmable. WM8311 detects and handles battery fault conditions with a minimum of system software involvement.

A 12-bit Auxiliary ADC supports a wide range of applications for internal as well as external analogue sampling, such as voltage detection and temperature measurement. The Touch Panel controller uses the same ADC on an interleaved basis.

WM8311 includes a crystal oscillator, an internal RC oscillator and Frequency Locked Loop (FLL) to generate all clock signals for autonomous system start-up and processor clocking. A Secure Real-Time Clock (S-RTC) and alarm function is included, capable of waking up the system from low-power modes. A watchdog function is provided to ensure system integrity.

To maximise battery life, highly-granular power management enables each function in the WM8311 subsystem to be independently powered down through a control interface or alternatively through register and OTP-configurable GPIOs. The device offers a standby power consumption of <10uA, making it particularly suitable for portable applications.

The WM8311 is supplied in a 8x8mm 121-ball BGA package, ideal for use in portable systems. The WM8311 forms part of the Wolfson series of audio and power management solutions.

### FEATURES

#### Power Management

- 2 x DC-DC synchronous buck converter (0.6V - 1.8V, 1.2A, DVS)
- 1 x DC-DC synchronous buck converter (0.85V - 3.4V, 1A)
- 1 x DC-DC boost converter (up to 30V, up to 170mA)
- 1 x LDO regulator (0.9V - 3.3V, 300mA, 1Ω)
- 2 x LDO regulators (0.9V - 3.3V, 200mA, 1Ω)
- 2 x LDO regulators (0.9V - 3.3V, 100mA, 2Ω)
- 1 x Low-noise LDO regulators (1.0V - 3.5V, 200mA, 1Ω)
- 1 x 'alive' regulator (0.8V - 1.55V, up to 10mA)

#### Backlight LED Current Sinks

- 2 x programmable constant current sinks, suitable for multi-LED display backlight control

#### Battery Charger

- Programmable single-cell lithium-ion / lithium-polymer battery charger (1A max charge current)
- Battery monitoring for temperature and voltage
- Autonomous backup battery charging and switching

#### System Control

- I<sup>2</sup>C or SPI compatible primary control interface
- Interrupt-based feedback communication scheme
- Watchdog timer and system reset control
- Autonomous power sequencing and fault detection
- Intelligent power path and power source selection
- OTP memory bootstrap configuration function

#### Additional Features

- Auxiliary ADC for multi-function analogue measurement
- Touch Panel interface controller (4-wire and 5-wire)
- 128-bit pseudo-random unique ID
- Secure Real-Time Clock with wake-up alarm
- 16 x configurable multi-function (GPIO) pins
- Comprehensive clocking scheme: low-power 32kHz RTC crystal oscillator, Frequency Locked Loop, GPIO clock output and 4MHz RC clock for power management
- System LED outputs indicating power state, battery charger or fault status
- Selectable USB current limiting up to 1.8A (in accordance with USB Battery Charging specification Rev 1.1)

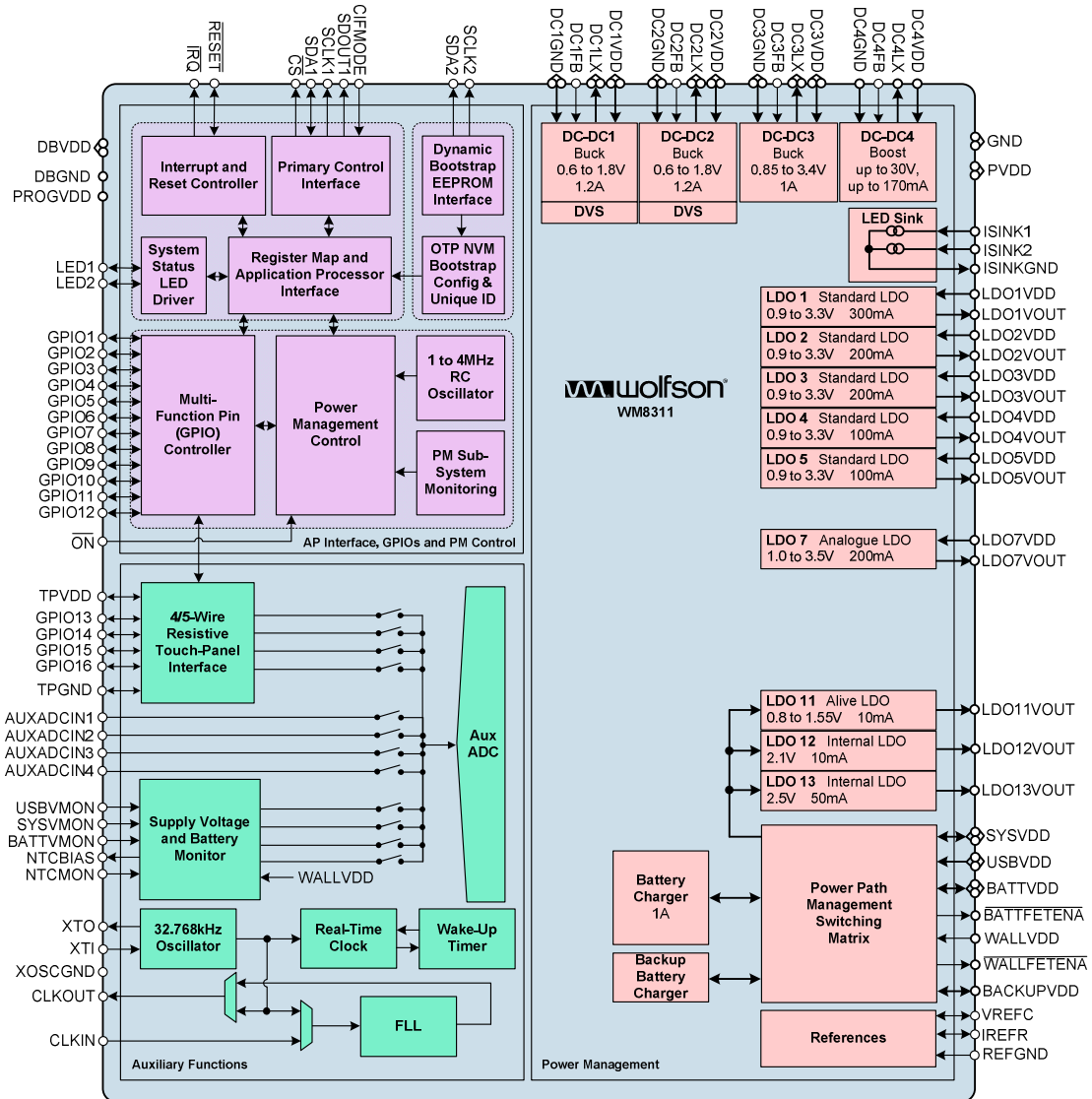
#### Package Options

- 8x8mm, 121-ball BGA package, 0.65mm ball pitch

### APPLICATIONS

- Portable Media Players
- Portable Navigation Devices
- Cellular Handsets
- Electronic Books
- Electronic Gaming Devices

BLOCK DIAGRAM



## TYPICAL APPLICATIONS

The WM8311 is designed as a system PMIC device that manages multiple power supply paths (wall adapter, USB, battery) and generates configurable DC supplies to power processors and associated peripherals within a system. The WM8311 provides three step-down DC-DC converters and one step-up DC-DC converter. Seven LDO regulators provide a high degree of flexibility to provide power to multiple devices, with the capability to power-up and power-down different circuits independently.

Two of the DC-DC step-down converters are specifically designed to handle rapid changes in load current, as required by modern application processors; selectable operating modes allow the converters to be optimally configured for light, heavy or transient load conditions; they can also be tailored for minimum PCB area, maximum performance, or for maximum efficiency. The analogue LDOs provide low-noise outputs suitable for powering sensitive circuits such as RF / Wi-Fi / bluetooth radio applications.

The WM8311 powers up the converters and LDOs according to a programmable sequence. A configurable 'SLEEP' state is also available, providing support for an alternate configuration, typically for low-power/standby operation. The power control sequences and many other parameters can be stored in an integrated user-programmable OTP memory or may be loaded from an external memory. The WM8311 supports autonomous programming and verification of the integrated OTP memory.

The WM8311 provides power path management which seamlessly switches between wall adapter, USB and battery power sources according to the prevailing conditions. A backup battery supply is also supported in order to maintain the Real Time Clock (RTC) in the absence of any other supplies. The WM8311 provides a battery charger for the main battery as well as the backup battery; these can be powered from either the wall adapter or USB supplies.

Programmable GPIO pins may be configured as hardware inputs for general use or for selecting different power management configurations. As outputs, the GPIOs can provide indications of the device status, or may be used as control signals for other power management circuits. The WM8311 also provides two LED drivers, which can be controlled manually or configured as status indicators for the OTP memory programmer, operating power state or battery charger.

## PIN CONFIGURATION

	1	2	3	4	5	6	7	8	9	10	11	
A	PVDD1	DC3VDD	DC3LX	DC3GND	DC2VDD	DC2LX	DC2GND	DC1GND	DC1LX	DC1VDD	DC1FB	A
B	BATTFETEN A_N	DC3VDD	DC3LX	DC3GND	DC2VDD	DC2LX	DC2GND	DC1GND	DC1LX	DC1VDD	GND	B
C	GND	PROGVDD	DC3FB	GND	DC2FB	SDA1	SCLK1	CS_N	RESET_N	GPIO1	DBVDD1	C
D	LDO5VDD	LDO5VOUT	GND	IRQ_N	SDOUT1	GPIO3	GPIO7	GPIO8	GPIO9	LDO13VOUT	GPIO2	D
E	LDO4VDD	LDO4VOUT	GPIO4	GPIO5	GPIO6	GPIO10	GPIO12	GND	DC4LX	DC4VDD	DC4FB	E
F	USBVMON	USBVMON	NTCBIAS	GPIO14	GPIO15	LED1	LED2	GPIO13	TPVDD	GPIO11	DC4GND	F
G	LDO7VDD	LDO7VOUT	SYSVMON	BATTVMON	NTCMON	ON_N	SCLK2	ISINK2	LDO11VOUT	GPIO16	TPGND	G
H	LDO3VDD	LDO3VOUT	CLKOUT	WALLVDD	SYSVDD	SYSVDD	IREFR	SDA2	ISINK1	ISINKGND	AUXADCIN4	H
J	LDO2VDD	LDO2VOUT	CLKIN	WALLFETE NA_N	SYSVDD	SYSVDD	VREFC	LDO12VOUT	XTO	BACKUPV D	REFGND	J
K	LDO1VDD	LDO1VOUT	DBVDD2	USBVDD	SYSVDD	BATTVDD	USBVDD	LDO12VOUT	XOSCGND	AUXADCIN1	AUXADCIN2	K
L	GND	CIFMODE	DBGND	USBVDD	USBVDD	BATTVDD	USBVDD	PVDD2	XTI	GND	AUXADCIN3	L

**8x8 BGA - TOP VIEW (WM8311)**

## ORDERING INFORMATION

ORDER CODE	TEMPERATURE RANGE (T <sub>A</sub> )	PACKAGE	MOISTURE SENSITIVITY LEVEL	PEAK SOLDERING TEMPERATURE
WM8311GEB/V	-40°C to +85°C	121-ball (8 x 8mm) (Pb-free)	MSL3	260°C
WM8311GEB/RV	-40°C to +85°C	121-ball (8 x 8mm) (Pb-free, tape and reel)	MSL3	260°C

**Note:**

Reel quantity = 2200

## PIN DESCRIPTION

### Notes:

1. Pins are sorted by functional groups.
2. The power domain associated with each pin is noted; VPMIC is the domain powered by LDO12 for the 'always-on' functions internal to the WM8311.

PIN	NAME	TYPE	POWER DOMAIN	DESCRIPTION
<b>Touch Panel and Auxiliary ADC</b>				
F1, F2	USBVMON	Analogue Input	USBVDD	USBVDD Supply Voltage Monitor
G3	SYSVMON	Analogue Input	SYSVDD	SYSVDD Supply Voltage Monitor
G4	BATTVMON	Analogue Input	BATTVDD	BATTVDD Supply Voltage Monitor
K10	AUXADCIN1	Analogue Input/Output	SYSVDD	Auxiliary Analogue Input 1 / Battery Charge Current Monitor Output
K11	AUXADCIN2	Analogue Input		Auxiliary Analogue Input 2
L11	AUXADCIN3	Analogue Input		Auxiliary Analogue Input 3
H11	AUXADCIN4	Analogue Input	TPVDD	Auxiliary Analogue Input 4
F9	TPVDD	Supply		Touch panel VDD supply
G11	TPGND	Supply		Touch panel Power Ground
<b>Clocking and Real Time Clock</b>				
J9	XTO	Analogue Output	VPMIC	Crystal Drive Output
L9	XTI	Analogue Input		Crystal Drive Input or 32.768kHz CMOS Clock Input
K9	XOSCGND	Supply		Crystal Oscillator Ground
H3	CLKOUT	Digital Output	DBVDD2	CMOS Clock Output
J3	CLKIN	Digital Input		CMOS FLL Clock Input
<b>General Purpose Input / Output</b>				
C10	GPIO1	Digital I/O	DBVDD1 or VPMIC	GPIO Pin 1
D11	GPIO2	Digital I/O		GPIO Pin 2
D6	GPIO3	Digital I/O		GPIO Pin 3
E3	GPIO4	Digital I/O	DBVDD1 or SYSVDD	GPIO Pin 4
E4	GPIO5	Digital I/O		GPIO Pin 5
E5	GPIO6	Digital I/O		GPIO Pin 6
D7	GPIO7	Digital I/O	DBVDD1 or VPMIC	GPIO Pin 7
D8	GPIO8	Digital I/O		GPIO Pin 8
D9	GPIO9	Digital I/O		GPIO Pin 9
E6	GPIO10	Digital I/O	DBVDD1 or SYSVDD	GPIO Pin 10
F10	GPIO11	Digital I/O		GPIO Pin 11
E7	GPIO12	Digital I/O		GPIO Pin 12
F8	GPIO13	Digital I/O	TPVDD	GPIO Pin 13 / Touch panel interface
F4	GPIO14	Digital I/O		GPIO Pin 14 / Touch panel interface
F5	GPIO15	Digital I/O		GPIO Pin 15 / Touch panel interface
G10	GPIO16	Digital I/O		GPIO Pin 16 / Touch panel interface
<b>Processor Interface and IC Control</b>				
G6	ON	Digital Input	VPMIC	ON Request Pin (Internal pull-up)
C9	RESET	Digital I/O	DBVDD1	System Reset Input and Open Drain Output. (Internal pull-up)
D4	IRQ	Digital Output	DBVDD1	PMIC Interrupt Flag Output. Configurable Open Drain / CMOS mode. (Internal pull-up in Open Drain mode.)

PIN	NAME	TYPE	POWER DOMAIN	DESCRIPTION
L2	CIFMODE	Digital Input	DBVDD2	Primary Control Interface Mode Select: 0 = I <sup>2</sup> C Compatible Control Interface Mode 1 = SPI Compatible Control Interface Mode
				<i>SPI Compatible Control Interface Mode</i>
				<i>I<sup>2</sup>C Compatible Control Interface Mode</i>
D5	SDOUT1	Digital Output	DBVDD1	Control Interface Serial Data Out
C7	SCLK1	Digital Input		Control Interface Serial Clock
C6	SDA1	Digital I/O		Control Interface Serial Data In
C8	CS	Digital Input		Control Interface Chip Select
				No Function
				Control Interface Serial Data Input and Open Drain Output. (Output can extend above DBVDD1 domain.)
				I <sup>2</sup> C Address Select: 0 = 0x68h 1 = 0x6Ch
G7	SCLK2	Digital I/O	VPMIC	Control Interface Serial Clock for external DBE EEPROM (Internal pull-down)
H8	SDA2	Digital I/O		Control Interface Serial Data to/from external DBE EEPROM (Internal pull-down)
C11	DBVDD1	Supply		Digital Buffer Supply
K3	DBVDD2	Supply		Digital Buffer Supply
L3	DBGND	Supply		Digital Buffer Ground
<b>OTP Memory</b>				
C2	PROGVDD	Supply		High-voltage input for OTP programming.
<b>DC-DC Converters and LDO Regulators</b>				
B11, C1, C4, D3, E8, L1, L10	GND	Supply		Ground
A1	PVDD1	Supply		Internal VDD supply; Connect to SYSVDD
L8	PVDD2	Supply		
A8, B8	DC1GND	Supply		DC-DC1 Power Ground
A11	DC1FB	Analogue Input	DC1VDD	DC-DC1 Feedback Pin
A9, B9	DC1LX	Analogue I/O		DC-DC1 Inductor Connection
A10, B10	DC1VDD	Supply		DC-DC1 Power Input
A7, B7	DC2GND	Supply		DC-DC2 Power Ground
C5	DC2FB	Analogue Input	DC2VDD	DC-DC2 Feedback Pin
A6, B6	DC2LX	Analogue I/O		DC-DC2 Inductor Connection
A5, B5	DC2VDD	Supply		DC-DC2 Power Input
A4, B4	DC3GND	Supply		DC-DC3 Power Ground
C3	DC3FB	Analogue Input	DC3VDD	DC-DC3 Feedback Pin
A3, B3	DC3LX	Analogue I/O		DC-DC3 Inductor Connection
A2, B2	DC3VDD	Supply		DC-DC3 Power Input
F11	DC4GND	Supply		DC-DC4 Power Ground
E11	DC4FB	Analogue Input	DC4VDD	DC-DC4 Feedback Connection
E9	DC4LX	Analogue I/O		DC-DC4 Inductor Connection
E10	DC4VDD	Supply		DC-DC4 Power Input
K1	LDO1VDD	Supply		LDO1 Power Input

PIN	NAME	TYPE	POWER DOMAIN	DESCRIPTION
K2	LDO1VOUT	Analogue Output	LDO1VDD	LDO1 Power Output
J1	LDO2VDD	Supply		LDO2 Power Input
J2	LDO2VOUT	Analogue Output	LDO2VDD	LDO2 Power Output
H1	LDO3VDD	Supply		LDO3 Power Input
H2	LDO3VOUT	Analogue Output	LDO3VDD	LDO3 Power Output
E1	LDO4VDD	Supply		LDO4 Power Input
E2	LDO4VOUT	Analogue Output	LDO4VDD	LDO4 Power Output
D1	LDO5VDD	Supply		LDO5 Power Input
D2	LDO5VOUT	Analogue Output	LDO5VDD	LDO5 Power Output
G1	LDO7VDD	Supply		LDO7 Power Input
G2	LDO7VOUT	Analogue Output	LDO7VDD	LDO7 Power Output
G9	LDO11VOUT	Analogue Output		LDO11 (Alive) Power Output
J10, K10	LDO12VOUT	Analogue I/O		LDO12 (Internal VPMIC) Output; not for general use
D10	LDO13VOUT	Analogue I/O	PVDD2	LDO13 (Internal INTVDD) Output; not for general use
<b>Current Sinks</b>				
H9	ISINK1	Analogue Output	SYSVDD	LED String Current Sink 1
G8	ISINK2	Analogue Output		LED String Current Sink 2
H10	ISINKGND	Supply		LED String Current Sink Ground
<b>Voltage and Current References</b>				
J7	VREFC	Analogue I/O	VPMIC	Voltage Reference capacitor connection point
H7	IREFR	Analogue I/O		Current Reference resistor connection point
J11	REFGND	Supply		Reference Ground
<b>Power Path Management</b>				
H5, H6, J5, J6, K5	SYSVDD	Supply		System VDD Supply
K4, K7, L4, L5, L7	USBVDD	Supply		USB VDD Supply
K6, L6	BATTVDD	Supply		Primary Battery Supply
B1	BATTFETENA	Digital Output	PVDD1	External Battery FET Driver
H4	WALLVDD	Supply		Wall VDD Supply/Sense
J4	WALLFETENA	Digital Output	highest VDD supply	External Wall FET Driver. Power domain is the highest out of WALLVDD, USBVDD or BATTVDD.
F3	NTCBIAS	Analogue Output	VPMIC	Battery NTC Temperature Monitor Supply
G5	NTCMON	Analogue Input		Battery NTC Temperature Monitor Voltage Sense Input
J10	BACKUPVDD	Supply		Secondary (Backup) Battery Supply
<b>System LED Drivers</b>				
F6	LED1	Digital Output	SYSVDD	Status LED Driver 1. Open Drain Output
F7	LED2	Digital Output		Status LED Driver 2. Open Drain Output

## ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings are stress ratings only. Permanent damage to the device may be caused by continuously operating at or beyond these limits. Device functional operating limits and guaranteed performance specifications are given under Electrical Characteristics at the test conditions specified.



ESD Sensitive Device. This device is manufactured on a CMOS process. It is therefore generically susceptible to damage from excessive static voltages. Proper ESD precautions must be taken during handling and storage of this device.

Wolfson tests its package types according to IPC/JEDEC J-STD-020B for Moisture Sensitivity to determine acceptable storage conditions prior to surface mount assembly. These levels are:

MSL1 = unlimited floor life at <30°C / 85% Relative Humidity. Not normally stored in moisture barrier bag.

MSL2 = out of bag storage for 1 year at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

MSL3 = out of bag storage for 168 hours at <30°C / 60% Relative Humidity. Supplied in moisture barrier bag.

The WM8311 has been classified as MSL3.

CONDITION	MIN	MAX
OTP Programming Supply (PROGVDD)	-0.3V	7.0V
BATTVDD, WALLVDD and USBVDD supplies	-0.3V	7.0V
Input voltage for LDO regulators	-0.3V	7.0V
Input voltage for DC-DC converters	-0.3V	7.0V
Digital buffer supply (DBVDD1, DBVDD2)	-0.3V	4.5V
Voltage range for digital inputs	-0.3V	DBVDD + 0.3V
Operating Temperature Range, T <sub>A</sub>	-40°C	+85°C
Junction Temperature, T <sub>J</sub>	-40°C	+125°C
Thermal Impedance Junction to Ambient, θ <sub>JA</sub>		45°C/W
Storage temperature prior to soldering	30°C max / 60% RH max	
Storage temperature after soldering	-65°C	+150°C
Soldering temperature (10 seconds)		+260°C
<b>Note:</b> These ratings assume that all ground pins are at 0V.		

## RECOMMENDED OPERATING CONDITIONS

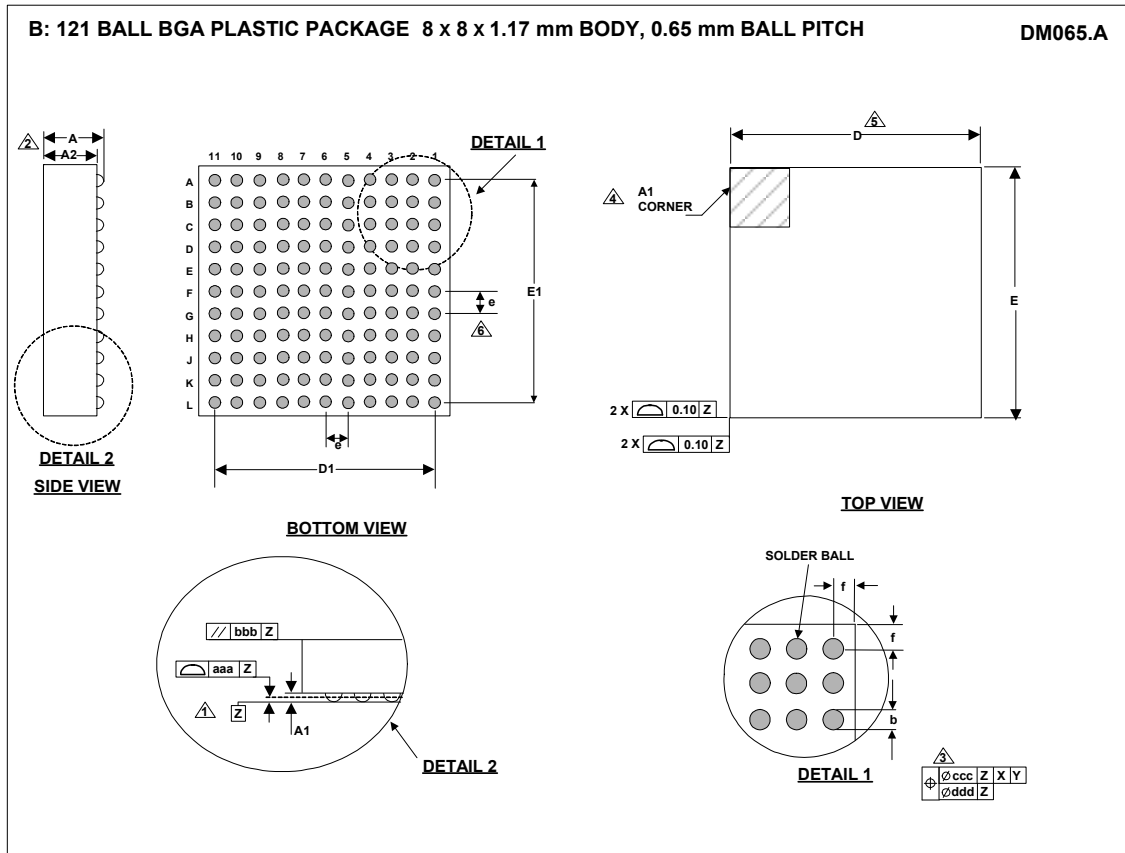
PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
Wall Input power source	WALLVDD	4.3		5.5	V
Battery Input power source	BATTVDD	2.7		5.5	V
USB Input power source	USBVDD	4.3		5.5	V
Backup Battery power source	BACKUPVDD			3.6	V
Digital buffer supply	DBVDD1, DBVDD2	1.71		3.6	V
Touch Panel supply (see note 1)	TPVDD	1.71	2.5	3.6	V
OTP Programming Supply (see note 2)	PROGVDD	6.25	6.5	6.75	V
Ground	GND, DBGND, TPGND, XOSCGND, REFGND		0		V

### Notes:

- When the Touch Panel Controller is enabled, then TPVDD must be connected to LDO13VOUT (2.5V). The min/max TPVDD conditions noted above do not apply when the Touch Panel Controller is enabled. (Note that, when the Touch Panel is not enabled, TPVDD is the power domain for GPIO pins 13-16.)
- The OTP Programming Supply PROGVDD should only be present when programming the OTP. At other times, this pin should be left unconnected.



**PACKAGE DIAGRAM**



Symbols	Dimensions (mm)			NOTE
	MIN	NOM	MAX	
A	1.08	1.17	1.27	
A1	0.17	0.21	0.26	
A2	0.91	0.96	1.01	
b	0.25	0.30	0.35	
D		8.00 BSC		
D1		6.50 BSC		
E		8.00 BSC		
E1		6.50 BSC		
e		0.65 BSC		6
f		0.75 BSC		
<b>Tolerances of Form and Position</b>				
aaa		0.08		
bbb		0.10		
ccc		0.15		
ddd		0.05		
REF:	JEDEC, MO-195			

- NOTES:
1. PRIMARY DATUM -Z- AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
  2. THIS DIMENSION INCLUDES STAND-OFF HEIGHT 'A1'.
  3. DIMENSION 'b' IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM -Z-.
  4. A1 CORNER IS IDENTIFIED BY INK/LASER MARK ON TOP PACKAGE.
  5. BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.
  6. 'e' REPRESENTS THE BASIC SOLDER BALL GRID PITCH.
  7. THIS DRAWING IS SUBJECT TO CHANGE WITHOUT NOTICE.
  8. FALLS WITHIN JEDEC, MO-195

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Testing and other quality control techniques are utilised to the extent Wolfson deems necessary to support its warranty. Specific testing of all parameters of each device is not necessarily performed unless required by law or regulation.

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